

Microchip**Filter specification****TFS1200****1/5****Measurement condition**

Ambient temperature T_A :	23	°C
Input power level:	0	dBm
Terminating impedance: *)		
Input:	168 Ω -1 pF	
Output:	168 Ω -1 pF	

Characteristics

Remark:

The reference level for the relative attenuation a_{rel} of the TFS1200 is the minimum of the pass band attenuation a_{min} . The minimum of the pass band attenuation a_{min} is defined as the insertion loss a_e . The centre frequency f_C is the arithmetic mean value of the upper and lower frequencies at the 3 dB filter attenuation level relative to the insertion loss a_e . The nominal frequency f_N is fixed at 1200 MHz without any tolerance. The given values for both the relative attenuation a_{rel} and the group delay ripple have to be achieved at the frequencies given below even if the centre frequency f_C is shifted due to the temperature coefficient of frequency TC_f within the operating temperature range and due to a production tolerance for the centre frequency f_C .

Data	typ. value		tolerance / limit		
Insertion loss (reference level)	a_e	3.25	dB	max.	6.0 dB
Nominal frequency	f_N	-		1200.0	MHz
Centre frequency	f_C	1200.0	MHz	-	
Passband	PB	-		f_N	± 100.0 kHz
Passband ripple	p-p ripple	0.3	dB	max.	1.0 dB
Relative attenuation	a_{rel}				
f_N	$\dots f_N \pm 0.1$ MHz	0.3	dB	max.	1 dB
$f_N \pm 3.0$ MHz	$\dots f_N \pm 6.0$ MHz	20	dB	min.	15 dB
$f_N \pm 6.0$ MHz	$\dots f_N \pm 17.0$ MHz	28	dB	min.	20 dB
$f_N + 17.0$ MHz	$\dots f_N + 30.0$ MHz	33	dB	min.	25 dB
$f_N + 30.0$ MHz	$\dots f_N + 180.0$ MHz	43	dB	min.	30 dB
$f_N - 17.0$ MHz	$\dots f_N - 1150.0$ MHz	39	dB	min.	30 dB
Group delay ripple within PB	GDR	19	ns	max.	100 ns
Input power level				max.	15 dBm
Operating temperature range	OTR	-		-40 °C ... +85 °C	
Storage temperature range		-		-55 °C ... +125 °C	
Frequency inversion temperature		40	°C	-	
Temperature coefficient of frequency	TC_f **)	0.05	ppm/K ²	-	

*) The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

**) $\Delta f = TC_f(T - T_0)^2 f_N$

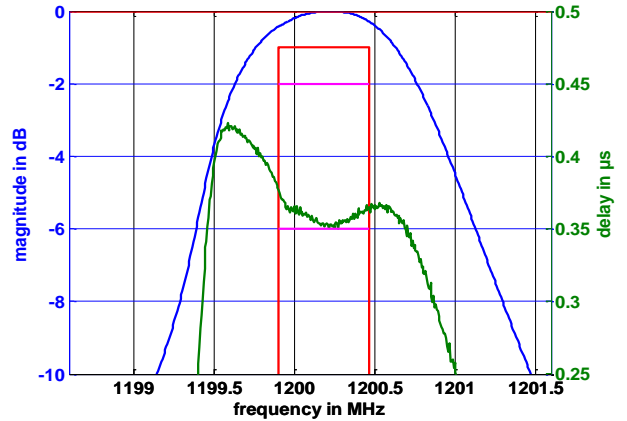
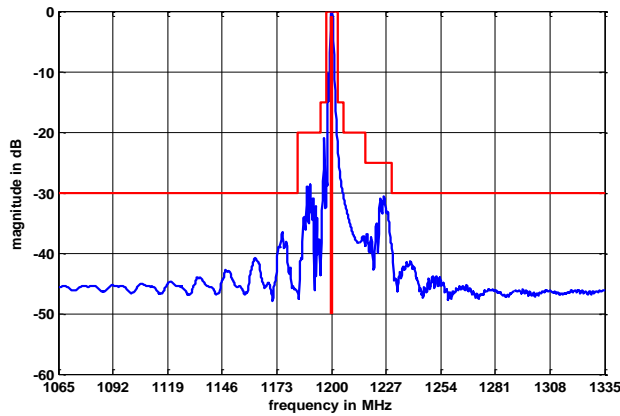
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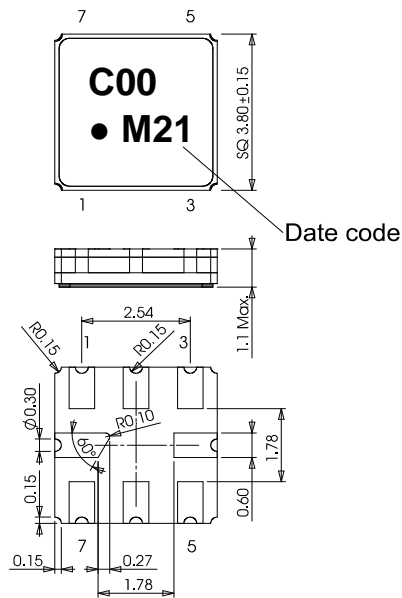
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Filter characteristic



Construction and pin connection

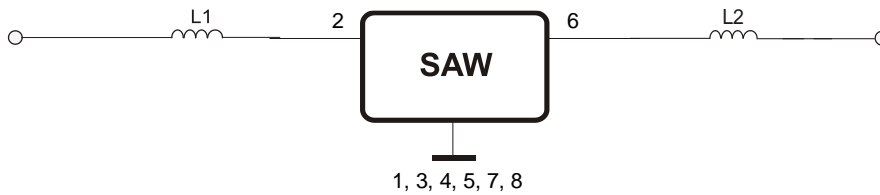
(All dimensions in mm)



- 1 Ground
- 2 Input
- 3 Ground
- 4 Ground
- 5 Ground
- 6 Output
- 7 Ground
- 8 Ground

Date code: Year + week
 M 2020
 N 2021
 P 2022
 ...

50 Ω Test circuit



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Stability characteristics, reliability

After the following tests the filter shall meet the whole specification:

1. Shock: 500 g, 1 ms, half sine wave, 3 shocks each plane;
DIN IEC 60068 T2 - 27
2. Vibration: 10 Hz to 2000 Hz, 0.35 mm or 5 g respectively, 1 octave per min, 10 cycles per plane, 3 planes; DIN IEC 60068 T2 - 6
3. Change of temperature: -55 °C to 125 °C / 15 min. each / 100 cycles
DIN IEC 60068 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: three times max.;
for temperature conditions refer to the attached "Air reflow temperature conditions" on page 4;
5. SAW devices are Electrostatic Discharge (ESD) sensitive devices.

This filter is RoHS compliant (2011/65/EU+2015/863/EU)

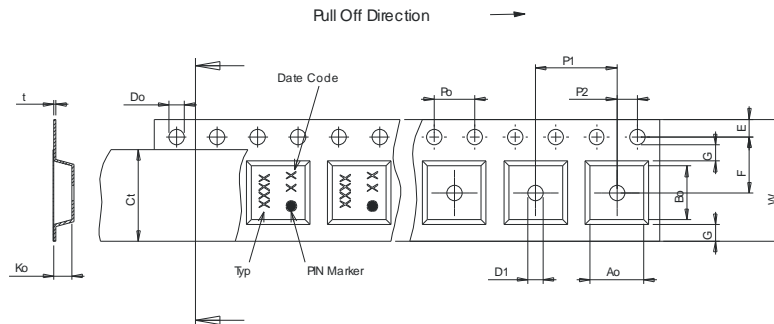
Packing

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

reel of empty components at start:	min. 300 mm
reel of empty components at start including leader:	min. 500 mm
trailer:	min. 300 mm

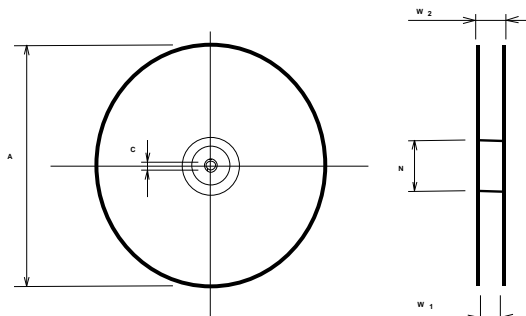
Tape (all dimensions in mm)

- W : 12.00 ±0.3
- Po : 4.00 ±0.1
- Do : 1.50 +0.1/-0
- E : 1.75 ±0.1
- F : 5.50 ±0.05
- G(min) : 0.75
- P2 : 2.00 ±0.05
- P1 : 8.00 ±0.1
- D1(min) : 1.50
- Ao : 4.30 ±0.1
- Bo : 4.30 ±0.1
- Ct : 9.2 ±0.1
- Ko : 1.80 ±0.1
- t : 0.30 ±0.05



Reel (all dimensions in mm)

- A : 330 or 180
- W1 : 12.4 +2/-0
- W2(max) : 18.40
- N(min) : 50.00
- C : 13.0 +0.5/-0.2



The minimum bending radius is 45 mm.

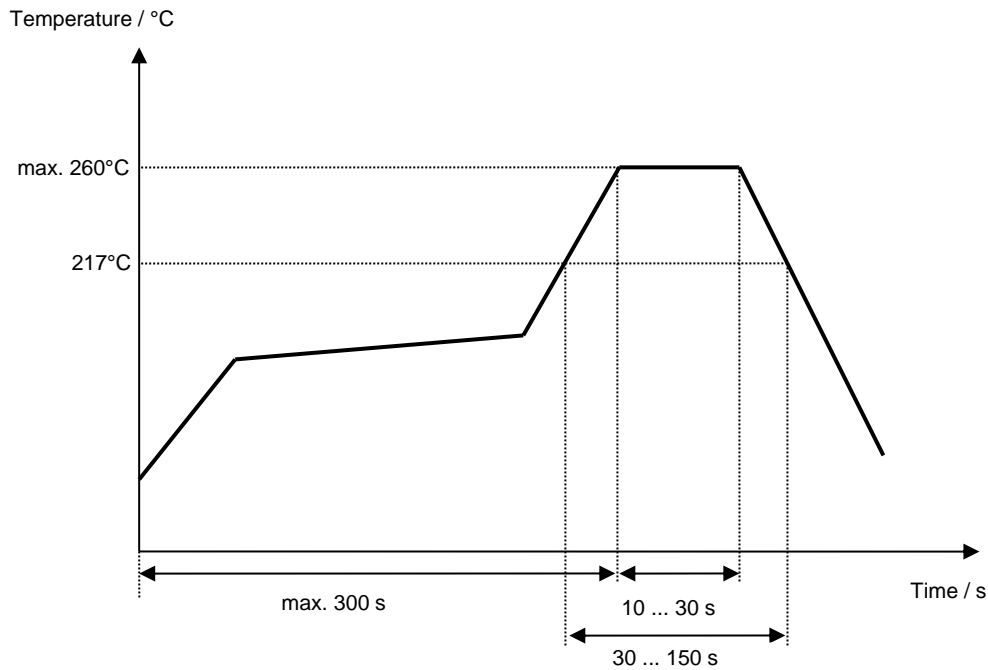
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Air reflow temperature conditions

Conditions	Exposure
Average ramp-up rate (30°C to 217°C)	less than 3°C/second
> 100°C	between 300 and 600 seconds
> 150°C	between 240 and 500 seconds
> 217°C	between 30 and 150 seconds
Peak temperature	max. 260°C
Time within 5°C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50°C)	less than 6°C/second
Time from 30°C to Peak temperature	no greater than 300 seconds

Chip-mount air reflow profile



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Microchip**Filter specification****TFS1200****5/5****History**

Version	Reason of Changes	Name	Date
1.0	- Generation of development specification	Strehl	13.06.2005
1.1	- Change of input power level to +15dBm	Sabah	06.07.2005
1.2	- Add of typical values and typical filter performances	Sabah	06.07.2005
1.3	- Improve limit line scheme - Change filter characteristic	Noack	09.06.2006
2.0	- Removed typ. value for input power level - Reformatted specification	P. Jaster	18.05.2020

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